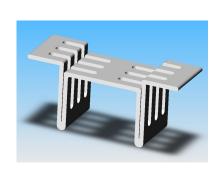
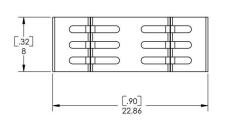
Board Level Heat Sinks

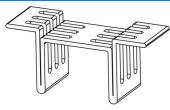


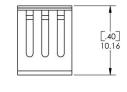
ThermaFlo

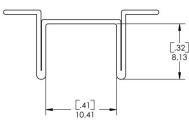
P/N: 834100T00000 & 8341TRT00000











PRODUCT SPECIFICATIONS -

Devices: D PAK, TO-252
Size: 22.9 x 8.0 x 10.2 mm
Material: Copper, 0.6 mm Thick

Type: Stamped

PCB Mounting: Surface Mount Technology

· Finish: Tin Plate

Package: Bulk or Tape & Reel

FEATURES & BENEFITS -

- No Hardware Device Attachment
- · Direct SMT Contact to PCB
- Solderable Legs
- RoHS Compliant



CUSTOMIZED HEATSINKS

- · Specialized Body Configurations
- Contact Applications Engineering

| | | Air Velo | ocity - LFM | | | | |
|---|-------------------------|------------|-------------|-----|-------------------------------|--|--|
| 0 | 200 | 400 | 600 | 800 | 1000 | | |
| ပ္စ 50 🕆 | | | | | 25 # 3 | | |
| ± 40 | | \ 1 | | | Thermal Resistance - °C/ Watt | | |
| e Amb 9 Surfa 1 Os | | ~ | | | 15 June - 3 | | |
| Rise Above Ambier (Mounting Surface) | | | | | Resista | | |
| np Ris | | | | | Thermal Resistance | | |
| U T | | | | | | | |
| 0 | 0 0.5 1 1.5 2 2.5 | | | | | | |
| | Heat Dissipated - Watts | | | | | | |

| Part Number | Packaging | Notes |
|--------------|-------------|---|
| 834100T00000 | Bulk | |
| 8341TRT00000 | Tape & Reel | Contact Factory for Tape and Reel Specs |

COMAIR ROTRON, INC